

COMPLEMENTARY SILICON PLASTIC POWER TRANSISTORS

... designed for use in general purpose power amplifier and switching applications.

FEATURES:

* Collector-Emitter Sustaining Voltage -V_{CEO(sue)}= 40V(Min)- TIP29,TIP30 60V(Min)- TIP29A,TIP30A 80V(Min)- TIP29B,TIP30B 100V(Min)-TIP29C,TIP30C

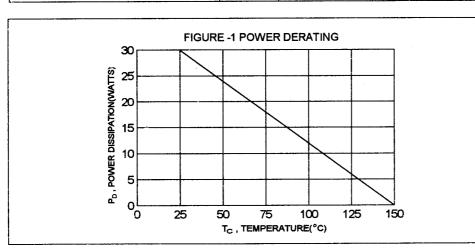
* Collector-Emitter Saturation Voltage- $V_{CE(sat)}$ =0.7 $V(Max)@I_C$ = 1.0 A * Current Gain-Bandwidth Product f_T =3.0 MHz (Min)@ I_C =200 mA

MAXIMUM RATINGS

Characteristic	Symbol	TIP29 TIP30	TIP29A TIP30A	TIP29B TIP30B	TIP29C TIP30C	Unit
Collector-Emitter Voltage	V _{CEO}	40	60	80	100	V
Collector-Base Voltage	V _{CBO}	40	60	80	100	٧
Emitter-Base Voltage	V _{EBO}	5.0			V	
Collector Current - Continuous - Peak	l _c	1.0 3.0			Α	
Base Current	l _B	0.4			Α	
Total Power Dissipation@T _C = 25°C Derate above 25°C	P _D	30 0.24			w/°c	
Operating and Storage Junction Temperature Range	T _J ,T _{STG}	-65 to +150			°C	

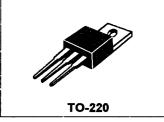
THERMAL CHARACTERISTICS

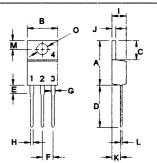
Characteristic	Symbol	Max	Unit
Thermal Resistance Junction to Case	Rθjc	4.167	°C/W



NPN	PNP
TIP29	TIP30
TIP29A	TIP30A
TIP29B	TIP30B
TIP29C	TIP30C

1.0 AMPERE **COMPLEMENTARY SILICON** POWER TRANSISTORS 40-100 VOLTS 30 WATTS





PIN 1.BASE 2.COLLECTOR 3.EMITTER 4.COLLECTOR(CASE)

DIM	MILLIMETERS			
אונט	MIN	MAX		
Α	14.68	15.31		
В	9.78	10.42		
c	5.01	6.52		
D	13,06	14.62		
E	3.57	4.07		
F	2.42	3.66		
G	1.12	1.36		
Н	0.72	0.96		
ı	4.22	4.98		
J	1.14	1.38		
K	2.20	2.97		
L	0.33	0.55		
M	2.48	2.98		
0	3.70	3.90		

ELECTRICAL CHARACTERISTICS (T_c = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Collector-Emitter Sustaining Voltage(1) (I _C = 30 mA, I _B = 0)	TIP29,TIP30 TIP29A,TIP30A TIP29B,TIP30B TIP29C,TIP30C	V _{CEO(sus)}	40 60 80 100		V
· CE · D ·	30,TIP29A,TIP30A IP30B,TIP29C,TIP30C	CEO		0.3 0.3	mA
Collector Cutoff Current (V _{CE} = 40 V, V _{EB} = 0) (V _{CE} = 60 V, V _{EB} = 0) (V _{CE} = 80 V, V _{EB} = 0) (V _{CE} = 100 V, V _{EB} = 0)	TIP29,TIP30 TIP29A,TIP30A TIP29B,TIP30B TIP29C,TIP30C	l _{CES}		0.2 0.2 0.2 0.2	mA
Emitter Cutoff Current (V _{EB} = 5.0 V, I _C = 0)		IEBO		1.0	mA
ON CHARACTERISTICS (1)					
DC Current Gain (I _C =0.2 A, V _{CE} = 4.0 V) (I _C =1.0 A, V _{CE} = 4.0 V)		hFE	40 15	75	
Collector-Emitter Saturation Voltage (I _C = 1.0 A, I _B =125 mA)		V _{CE(sat)}		0.7	V
Base-Emitter On Voltage (I _C =1.0 A, V _{CE} = 4.0 V)		V _{BE(on)}		1.3	٧
DYNAMIC CHARACTERISTICS					
Current Gain - Bandwidth Product (2) (I _C = 200 mA , V _{CE} = 10 V , f = 1 MHz)		f _T	3.0		MHz
Small Signal Current Gain (I _C = 200 mA , V _{CE} = 10 V , f = 1 kHz)		h _{fe}	20		

⁽¹⁾ Pulse Test: Pulse width \leq 300 μ s , Duty Cycle \leq 2.0 %

⁽²⁾ $f_T = |h_{fe}| \circ f_{TEST}$

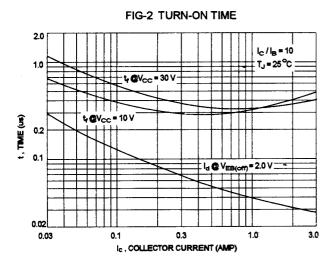


FIG-4 DC CURRENT GAIN

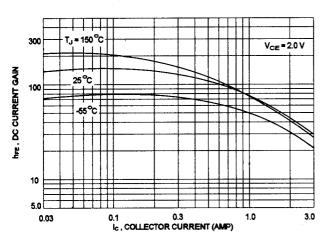


FIG-6 ACTIVE REGION SAFE OPERATING AREA

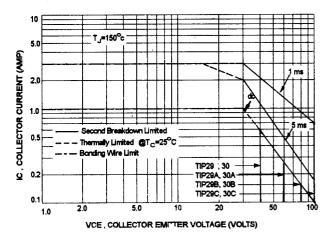


FIGURE 3 - SWITCHING TIME EQUIVALENT CIRCUIT

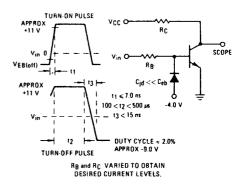
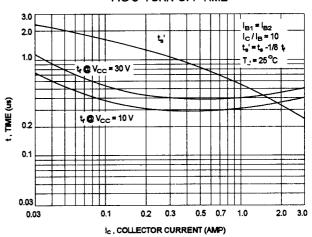


FIG-5 TURN-OFF TIME



There are two limitation on the power handling ability of a transistor:average junction temperature and second breakdown safe operating area curves indicate $I_{\text{C}}\text{-V}_{\text{CE}}$ limits of the transistor that must be observed for reliable operation i.e., the transistor must not be subjected to greater dissipation than curves indicate.

The data of FIG-6 curve is base on $T_{J(PK)}$ =150 °C; T_C is variable depending on power level, second breakdown pulse limits are valid for duty cycles to 10% provided $T_{J(PK)} \le 150$ °C, At high case temperatures, thermal limitation will reduce the power that can be handled to values less than the limitations imposed by second breakdown.